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CEDA 7000.5
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Brian Lewis et al.
Serial No. 10/722,288
Filed November 25, 2003
For THERMAL INTERFACE MATERIAL AND SOLDER PREFORMS

June 22, 2004

COMMISSIONER FOR PATENTS
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ALEXANDRIA, VIRGINIA 22313-1450

SIR:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

In accordance with 37.C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 CFR 1.56, applicants submit the enclosed PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

* Applicants enclose a copy of Ref. JP 05-070252 (Mitsubishi) listed on the attached form. Applicants do not enclose a copy of 5,907,474, pursuant to new PTO rules not requiring copies of U.S. patents.

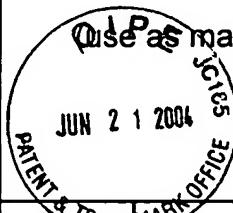
Respectfully submitted,

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**SUPPLEMENTAL
INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**



(Use as many sheets as necessary)

Sheet

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of

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<i>Complete if Known</i>	
Application Number	10/722,288
Filing Date	November 25, 2003
Confirmation Number	9116
First Named Inventor	Brian Lewis
Group Art Unit	1725
Examiner Name	To Be Assigned
Attorney Docket No.	CEDA 7000.5

U.S. PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	
		Number	Kind Code ² <i>(if known)</i>			
	36	5,907,474		Dolbear	05-25-1999	
FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	
		Office	Number ⁴			
	37	JP	05-070252	A2	Mitsubishi Materials Corp.	03/23/1993
OTHER ART - NON PATENT LITERATURE DOCUMENTS						
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.			T ⁶	

Examiner Signature		Date Considered
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached or place an "A" here if English language abstract is attached..

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